

# D-231

## SERVICE MANUAL



*US Model  
AEP Model  
UK Model  
E Model*

Model Name Using Similar Mechanism	D-232/235
Optical Device Name	KSM-331CAN (S)
Optical Pick-Up Name	KSS-331C

### SPECIFICATIONS

<b>System</b>	Compact disc digital audio system	<b>General</b>	
<b>Laser diode properties</b>	Material: GaAlAs Wavelength: $\lambda = 780$ nm Emission duration: Continuous Laser output: Less than 44.6 $\mu\text{W}$ (This output is the value measured at a distance of 200 mm from the objective lens surface on the Optical Pick-up Block.) Sony Super Strategy Cross Interleave Reed Solomon Code 1-bit quartz time-axis control	<b>Power requirements</b>	Supplied: • DC IN 4.5 V jack accepts the Sony AC power adaptor for use on:
<b>Error correction</b>	20 - 20,000 Hz $\pm 0.5$ dB (measured by EIAJ CP-307)		Where purchased European and Asian countries U.S.A. Middle East United Kingdom Other countries
<b>D-A conversion</b>			Operating voltage 220 - 230 V AC, 50 Hz 120 V AC, 60 Hz 110 - 240 V AC, 50/60 Hz 240 V AC, 50 Hz 100 - 240 V AC, 50/60 Hz
<b>Frequency response</b>			
<b>Output (at 4.5 V input level)</b>	Line output (stereo minijack) Output level 0.7 V rms at 47 kilohms Recommended load impedance over 10 kilohms Headphones (stereo minijack) 12 mW + 12 mW at 16 ohms	<b>Dimensions</b>	Not supplied: • Rechargeable battery BP-DM10 • DC 3 V, two size AA (LR6) alkaline batteries • DC IN 4.5 V accepts the Sony CPM-300PK mount arm for use on car battery
		<b>Mass</b>	Approx. 130 $\times$ 30.5 $\times$ 142 mm (5 $1\frac{1}{2}$ $\times$ 1 $1\frac{1}{4}$ $\times$ 5 $1\frac{1}{2}$ in.) (w/h/d) incl. projecting parts and controls
		<b>Supplied accessories</b>	Approx. 255 g (9.0 oz) not incl. rechargeable battery AC power adaptor (1) Connecting cord (phono plug $\times$ 2 $\leftrightarrow$ stereo miniplug) (1) Stereo headphones (1)

Design and specifications are subject to change without notice.

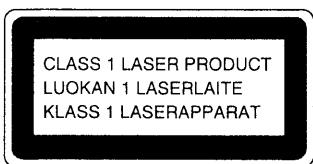
**COMPACT DISC COMPACT PLAYER**  
**SONY®**



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This Compact Disc player is classified as a CLASS 1 LASER product.  
The CLASS 1 LASER PRODUCT label is located on the bottom exterior.



### CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

### Flexible Circuit Board Repairing

- Keep the temperature of the soldering iron around 270°C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
- Be careful not to apply force on the conductor when soldering or unsoldering.

### Notes on chip component replacement

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

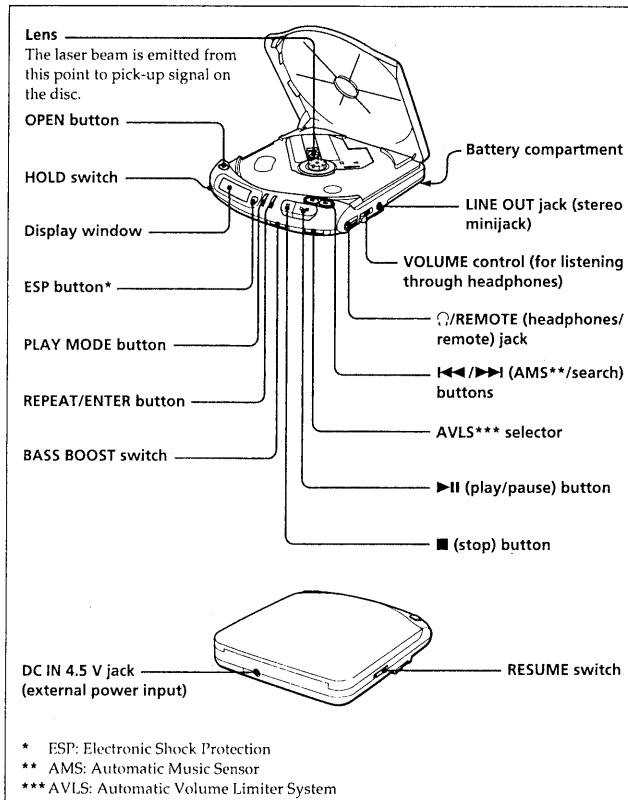
### SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK OR DOTTED LINE WITH MARK ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

## SECTION 1 GENERAL

This section is extracted from  
instruction manual.

## Location and Function of Controls



## SECTION 2 SERVICE NOTE

### NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic breakdown because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body.

During repair, pay attention to electrostatic breakdown and also use the procedure in the printed matter which is included in the repair parts.

The flexible board is easily damaged and should be handled with care.

### NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe from more than 30 cm away from the objective lens.

### Before Replacing the Optical Pick-Up Block

Please be sure to check thoroughly the parameters as per the "Optical Pick-Up Block Checking Procedures" (Part No.: 9-960-027-11) issued separately before replacing the optical pick-up block.

Note and specifications required to check are given below.

- FOK output: IC501 ⑫ pin  
When checking FOK, remove the lead wire to disc motor.
- S curve P-to-P value: 2.5 Vp-p  
When checking S curve P-to-P value, remove the lead wire to disc motor.
- Adjusted part for focus gain adjustment: RV503
- RF signal P-to-P value: 0.7 – 1.1 Vp-p
- Traverse signal P-to-P value: 1.2 – 2.0 Vp-p
- The repairing grating holder is impossible.
- Adjusted part for tracking gain adjustment: RV504

## SECTION 3

### SERVICE MODE

#### Precautions for Checking Emission of Laser Diode

Laser light of the equipment is focused by the object lens in the optical pick-up so that the light focuses on the reflection surface of the disc. Therefore, be sure to keep your eyes more than 30 cm apart from the object lens when you check the emission of laser diode.

#### Laser Diode Checking Methods

During normal operation of the equipment, emission of the laser diode is prohibited unless the upper panel is closed while turning ON the S810 (push switch type).

The following two checking methods for the laser diode are operable.

- **Method-1 (In the service mode or normal operation):**  
**Emission of the laser diode is visually checked.**

1. Open the upper panel.
  2. Push the S810 as shown in Fig. 1.
  3. Check the object lens for confirming normal emission of the laser diode. If not emitting, there is a trouble in the automatic power control circuit or the optical pick-up.
- During normal operation, the laser diode is turned ON about 2.5 seconds for focus searching.

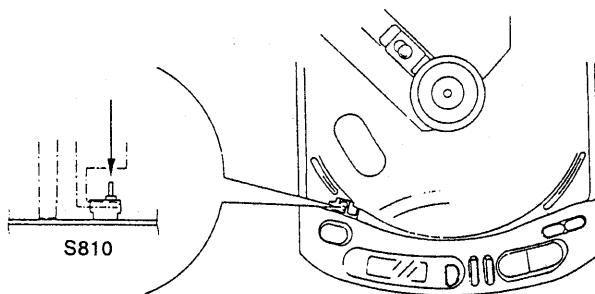
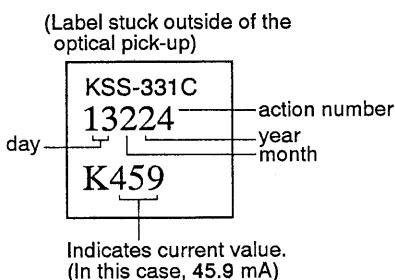


Fig. 1 Method to push the S810

- **Method-2 (In service mode or normal operation):**  
**Check the value of current flowing in the laser diode.**

1. Remove the upper panel.
2. Read the current printed on the label attached on the rear side of the optical pick-up.



3. Connect a VTVM as shown in Fig. 2.
4. Press the **►■** key.
5. Calculate current value by the reading of the VTVM.  
Reading of the tester (V) ÷ 1= current value (A)  
(Example) Reading of the VTVM of 0.046 V:  
 $0.046 \text{ V} \div 1 \Omega = 0.046 \text{ (A)} = 46 \text{ mA}$

6. Check that the current value is within the following range.

- Current value of the label  $\pm 5\%$  mA (25 °C)  
Variation by temperature: 0.4 mA/°C  
Current increases with temperature increased.  
Current decreases with temperature decreased.

If the current is more than the range above, there is a trouble in the automatic power control circuit or the laser diode is in deterioration.  
If less than the range, a trouble exists in the automatic power control circuit or the optical pick-up.

#### — MAIN BOARD — (Side A)

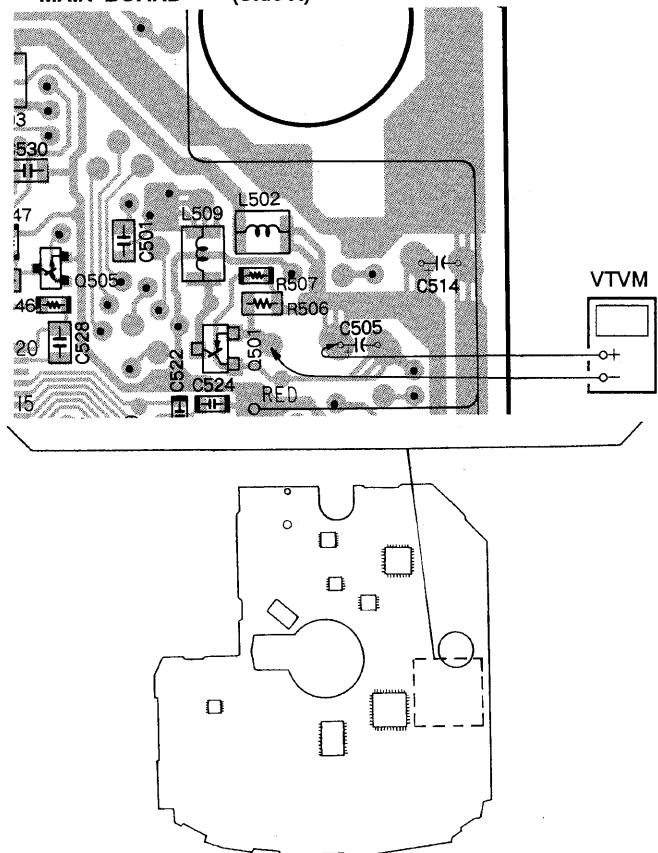
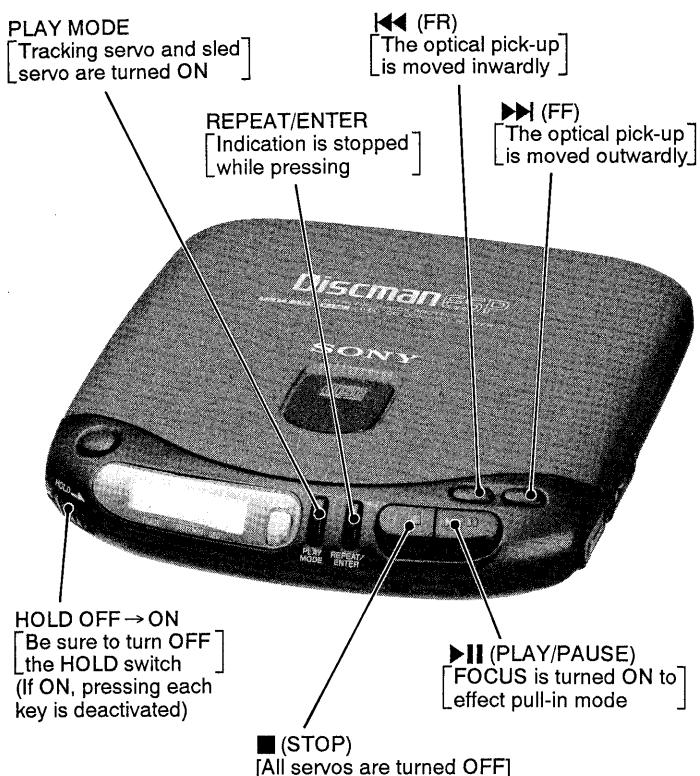


Fig. 2 VTVM connecting location

## Service Mode (Service program)

The equipment is provided with a service program built in the microcomputer, like conventional models.  
Service program operation methods are described in the following.



Descriptions in [ ] indicate major operations in the service mode. For more information, see Step 2.

Fig. 3 Layout of each key

### • Step 1 (Service mode setting methods)

1. Turn OFF the HOLD switch with external power supply disconnected (power is not applied to the set).
2. Solder across the TEST terminals (pin ⑧, IC801 (TEST) is grounded).
3. Connect an external power supply.

Thus, the set is switched to the service mode.

### • Step 2 (Operation in the service mode)

1. Once the service mode is effected, the LCD displays 5 indications each of which is repeatedly displayed.  
However, the following operations can be activated even if LCD indication is effected.
2. By pressing the ► or ▲ key, the optical pick-up is movable inwardly or outwardly. However, if this is activated, tracking servo and sled servo are turned OFF, so it can be turned ON by pressing the PLAY MODE key if required.
3. By pressing the REPEAT/ENTER key, the display stops.  
With the key released, repeated indication is continued, so you can check each segment.
4. By pressing the ► key, focus is turned ON from focus searching while entering CLV-S (pull-in mode).  
Without disc, focus searching is repeated continuously.
5. By pressing the PLAY MODE key, tracking servo, sled servo and CLV-A (servo in PLAY) are turned ON.
6. When 4. and 5. are performed, playing begins. No muting is ON in the service mode.

7. By pressing the ■ key, all servos (focus, tracking and sled) are turned OFF. However, the disc motor revolves for a while by inertia.

### • Step 3 (Resetting of service mode)

1. Be sure to disconnect the external power supply and remove the solder bridge at the TEST terminals connected before in setting.
2. The set thus becomes available for normal operation.

### - MAIN BOARD - (Side A)

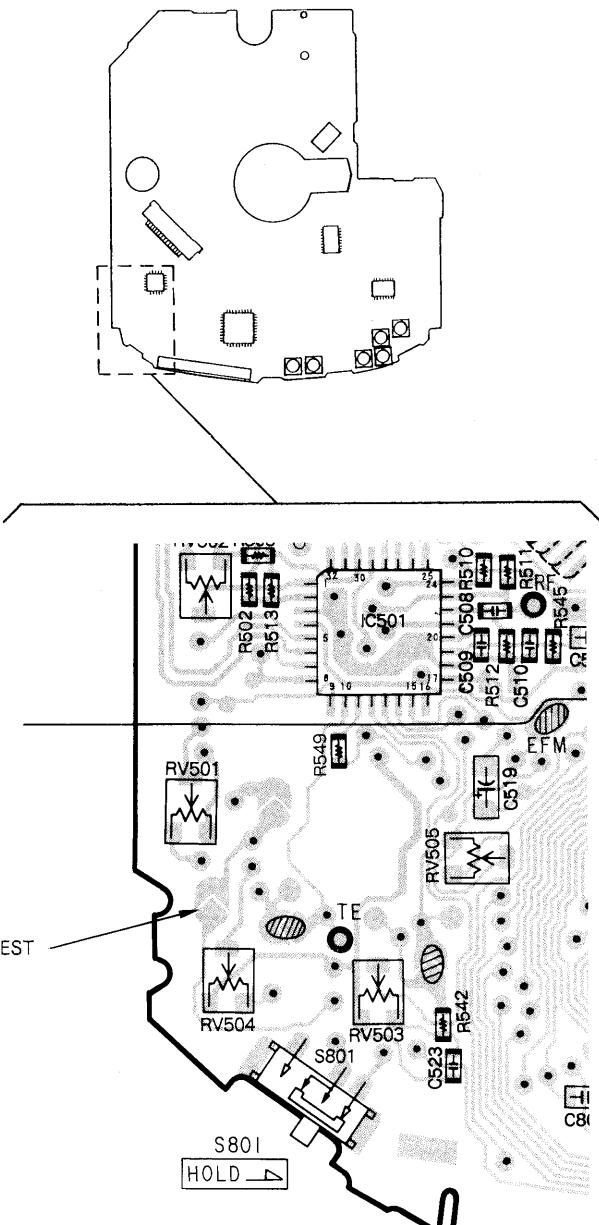


Fig. 4 Location of Test terminal

## SECTION 4

### ELECTRICAL ADJUSTMENTS

#### **CD SECTION**

##### **Precautions for Adjustment**

1. Before beginning adjustment, set the equipment to service mode.  
After the completion of adjustment, be sure to reset the service mode.  
For more information, see "Service Mode (service program)" on pages 5.
2. Perform adjustments in the order given.
3. Use YEDS-18 disc (Part No.: 3-702-101-01) unless otherwise indicated.
4. Power supply voltage requirement: DC4.5 V  
HOLD switch : OFF  
VOLUME switch : Minimum  
ESP switch : OFF  
BASS BOOST switch: NORM  
AVLS switch : OFF

##### **Before Beginning Adjustment**

Set the equipment to service mode (See page 5) and check the following.  
If there is an error, repair the equipment.

##### **• Checking of the sled motor**

1. Open the upper panel.
2. Press the **►►** and **◀◀** keys and check that the optical pick-up can move smoothly without sluggishness or abnormal noise in innermost periphery → outermost periphery → innermost periphery.  
**►►** : The optical pick-up moves outwardly.  
**◀◀** : The optical pick-up moves inwardly.

##### **• Checking of focus searching**

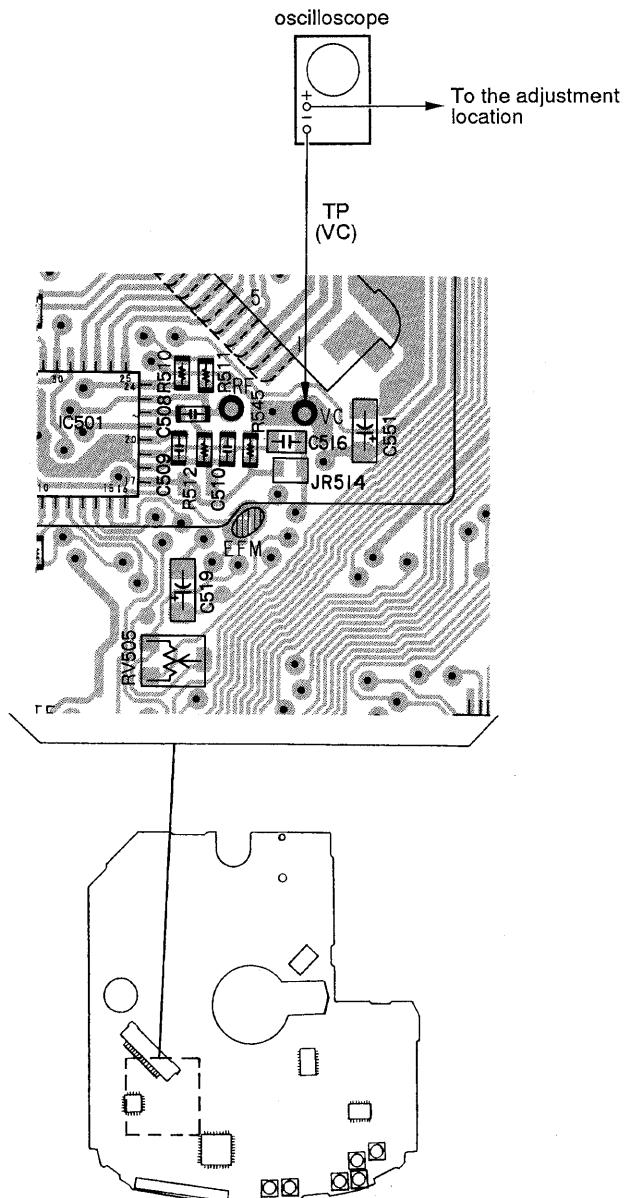
1. Open the upper panel.
2. Press the **►►** key. (Focus searching operation is activated continuously.)
3. Check the object lens of the optical pick-up for smooth up/down motion without sluggishness or abnormal noise.
4. Press the **■** key.  
Check that focus searching operation is deactivated. If not, again press the **■** key slightly longer.

##### **• VC (1/2 Vcc) connection location**

Focus bias adjustment  
Tracking balance adjustment  
For any of the adjustments above, connect the minus side of the oscilloscope at the point of the following view.

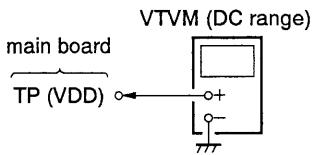
##### **Connection Location:**

###### **— MAIN BOARD — (Side A)**



## VDD Adjustment

### Adjustment Procedure:

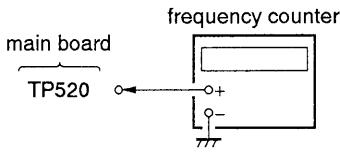


1. Set the equipment to service mode stop state. (See page 5.)
2. Connect the VTVM to TP (VDD) of the main board.
3. Adjust RV401 on the main board so that the reading on VTVM goes  $3.15 \pm 0.05$  V.
4. After the completion of adjustment, reset service mode. (See page 5.)

**Adjustment Location:** Main Board

## PLL Free Run Frequency Checking and Adjustment

### Checking and Adjustment Procedure:



1. Unsolder the solder-bridge on  $\textcircled{A}$  (EFM) as shown in Adjusting Parts Location. (See page 9.)
2. Connect the frequency counter to the test point TP520 of the main board.
3. Set the equipment to service mode stop state. (See page 5.)
4. Confirm the reading on the frequency counter is  $4.3518 \pm 0.01$  MHz. When it is out of order, Adjust RV505 to  $4.3518 \pm 0.01$  MHz.
5. After the completion of adjustment, reset service mode. (See page 5.)
6. Short-circuit  $\textcircled{A}$  (EFM).

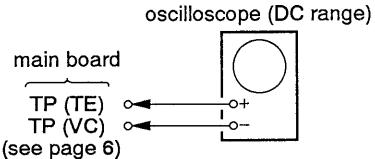
**Checking and Adjustment Location:** Main Board

## Tracking Balance Adjustment

### Condition:

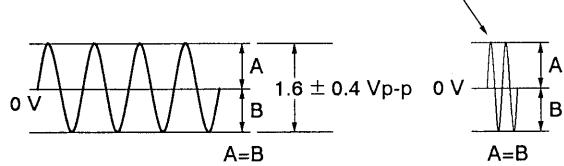
- Hold the set in horizontal state.

### Adjustment Procedure:



1. Connect the oscilloscope to TP (TE) of the main board.
2. Set the equipment to service mode stop state. (See page 5.)
3. Move the optical pick-up by pressing the  $\blacktriangleright\blacktriangleright$  and  $\blacktriangleleft\blacktriangleleft$  keys.
4. Put the disc (YEDS-18).
5. Press the  $\blacktriangleright\blacksquare$  key.  
[ From focus searching, focus is turned ON while entering CLV drawing-in mode. Tracking and sled are turned OFF. ]
6. Adjust RV502 so that the waveform on the oscilloscope becomes up/down symmetrical with an axis of 0 V.

**Note:** Take long sweep time for easy monitoring.



7. Stop removing of the disc motor by pressing the  $\blacksquare$  key.
8. After the completion of adjustment, reset service mode. (See page 5.)

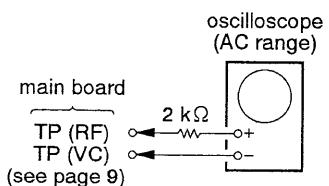
**Adjustment Location:** Main Board

## Focus Bias Adjustment

### Condition:

- Hold the set in horizontal state.

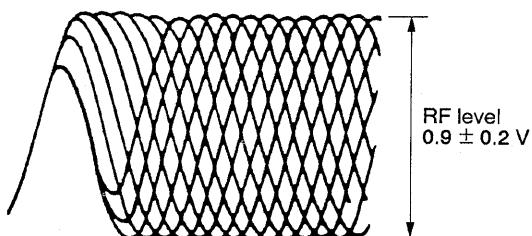
### Adjustment Procedure:



1. Set the equipment to service mode stop state. (See page 5.)
2. Connect the oscilloscope to the test point TP (RF) of the main board.
3. Move the optical pick-up by pressing the  $\blacktriangleright\blacktriangleright$  and  $\blacktriangleleft\blacktriangleleft$  keys.
4. Put the disc (YEDS-18).
5. Put the  $\blacktriangleright\blacksquare$  key.  
[ From focus searching, focus is turned ON while entering CLV drawing-in mode. Tracking and sled are turned OFF. ]
6. Press the PLAY MODE key. (Both tracking and sled are turned ON.)
7. Adjust RV501 so that the eye pattern in the waveform of the oscilloscope is clearly displayed. "Clear display of the eye pattern" means that the  $\diamond$  shape can be clearly discriminated at the center of the waveform.

### RF SIGNAL REFERENCE WAVEFORM (EYE PATTERN)

VOLT DIV : 200 mV (With the 10:1 probe in use)  
TIME DIV : 500 ns

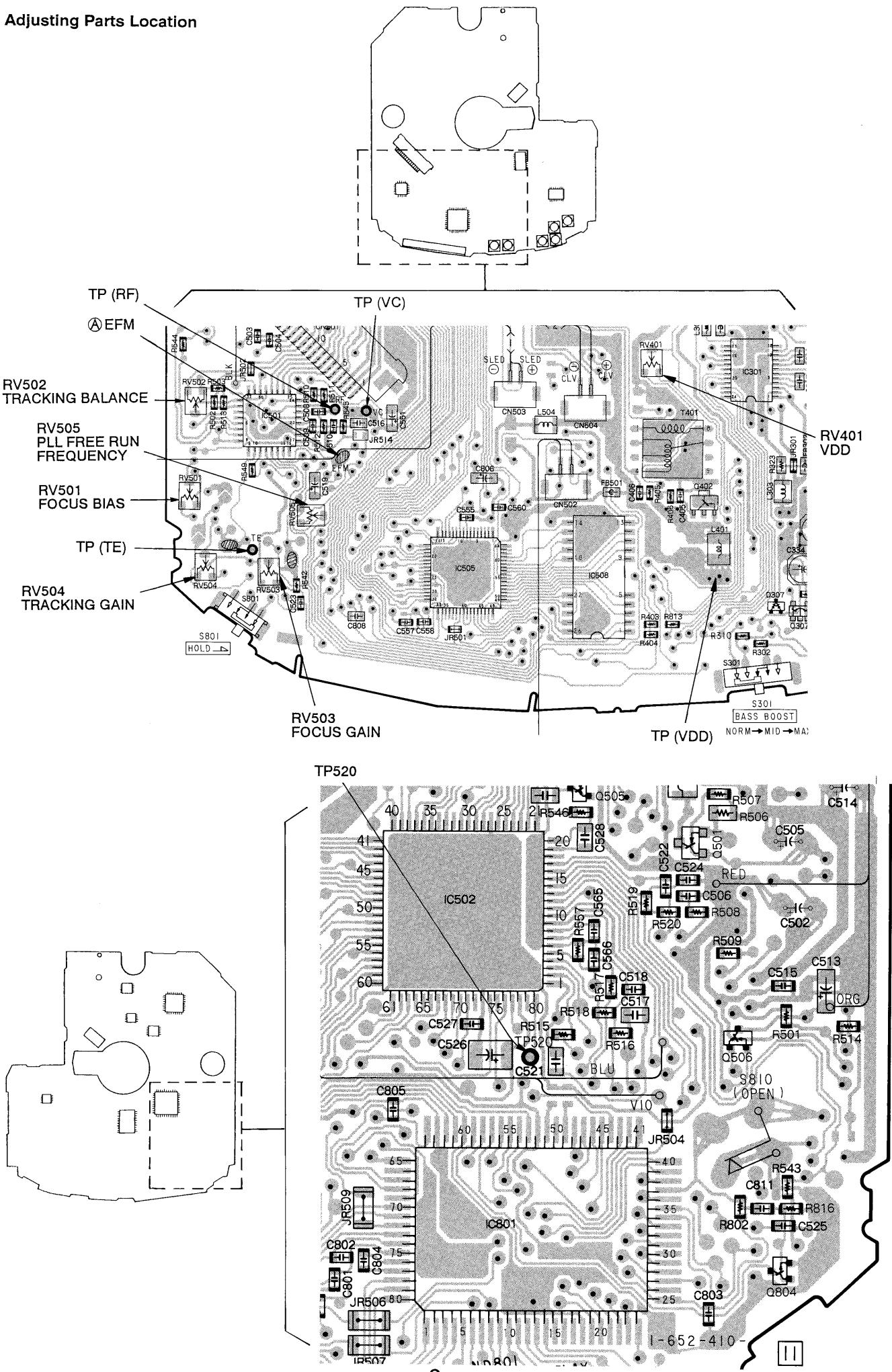


To watch the eye pattern, set the oscilloscope to AC range and increase the vertical sensitivity of the oscilloscope for easy watching.

8. Stop revolving of the disc motor by pressing the  $\blacksquare$  key.
9. After the completion of adjustment, reset service mode. (See page 5.)

**Adjustment Location:** Main Board

## Adjusting Parts Location



## Focus/Tracking Gain Adjustment

To perform this adjustment precisely, a servo analyser or CD jigs are required.

**However, there is an allowance for this gain, so substantially no problems occur normally even if it is slightly deviated. Therefore, you need not perform this adjustment.**

Focus/tracking gain determines the follow-up property of the pick-up to mechanical shocks during 2-axis device operation. However, since these requirements are inconsistent, the equipment is adjusted to compromise both properties.

- With gain increased, noise in 2-axis device operation also increases.
- With gain decreased, the equipment becomes less immune to mechanical shocks, where sound jumping often occurs.

This adjustment has to be performed upon replacing any of the following parts.

- Optical pick-up
- RV503 (Focus gain VR)
- RV504 (Tracking gain VR)

Normally, be sure not to move RV503 (focus gain VR) and RV504 (tracking gain VR).

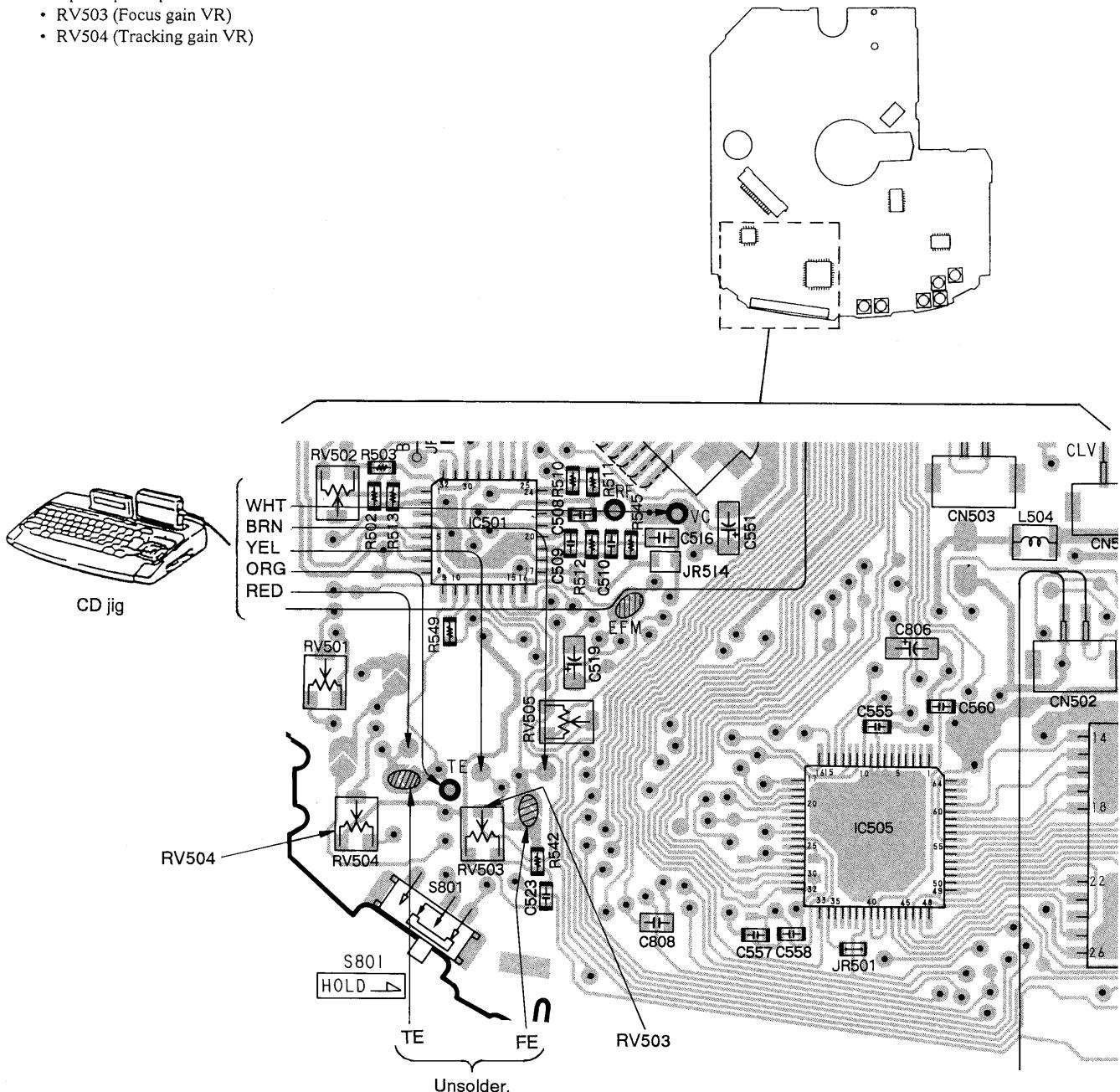
**With this equipment, it is very difficult to simply perform this adjustment.**

If the equipment is not so often suffering from "occasional sound jumping" or not easily decided for complete repairing, use the CD jigs for the adjustment. To connect the CD jigs, see the right view. For more detailed adjustment methods, see the separate CD jig operation manual.

### CD jig connecting methods:

Unsolder two lands and connect the equipment to the CD jigs as shown in the right view. At the time, connect the IC501 side and each VR side to the output to the CD jigs and the input from the CD jigs, respectively.

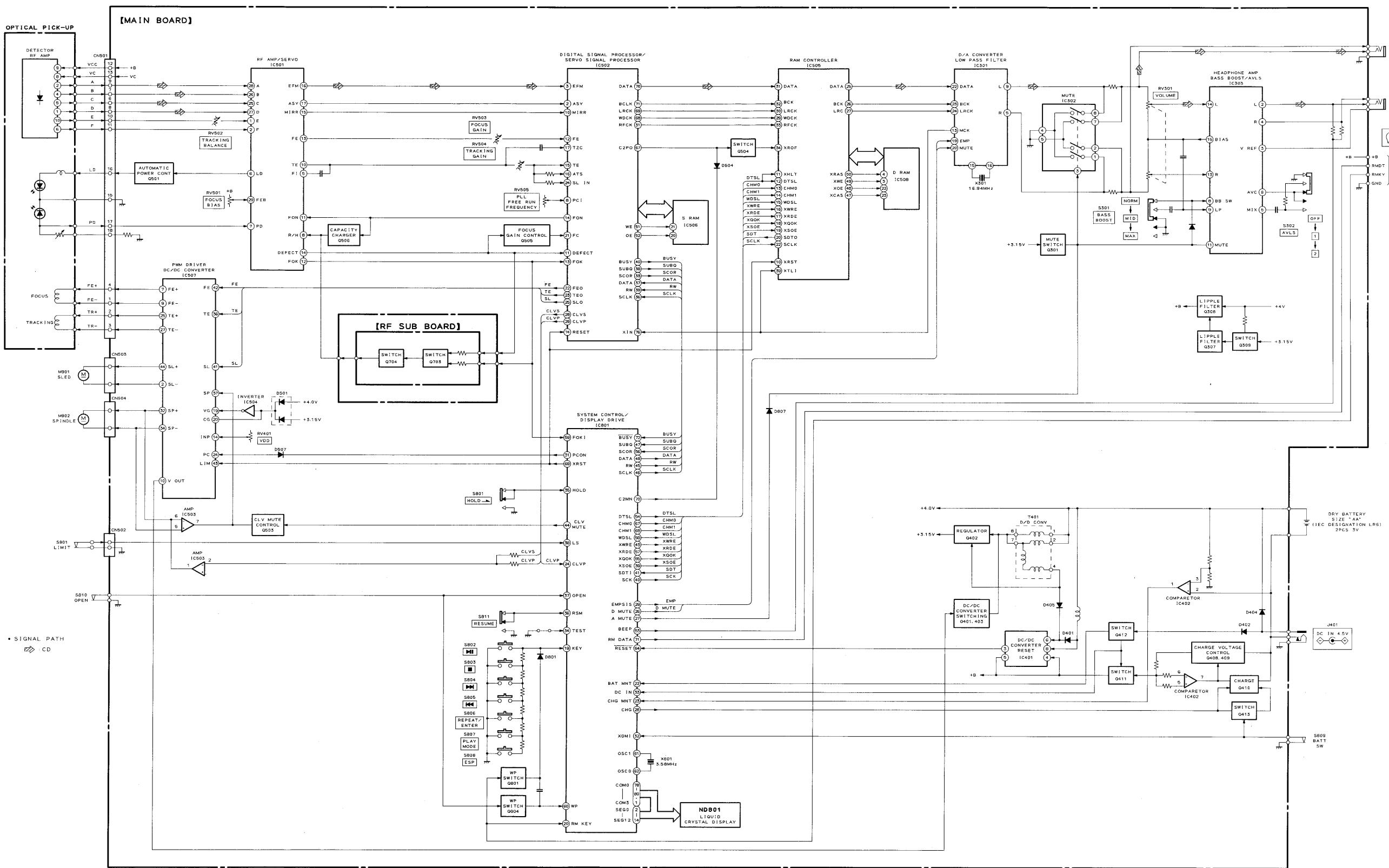
### Connection and Adjustment Location: Main Board



**SECTION 5**  
**DIAGRAMS**

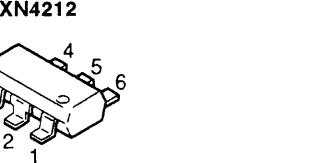
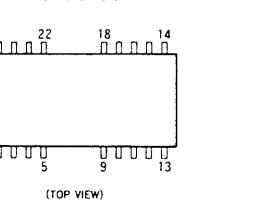
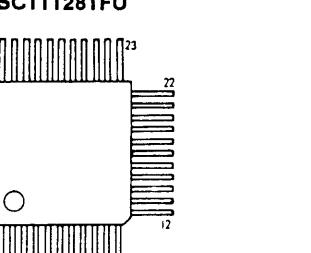
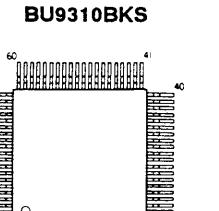
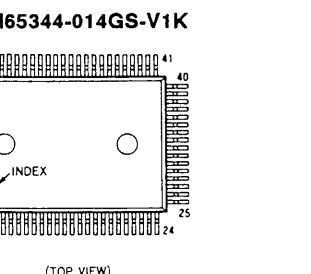
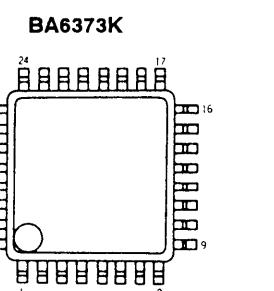
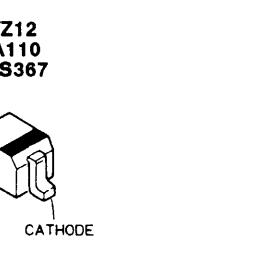
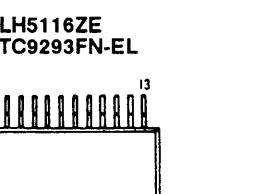
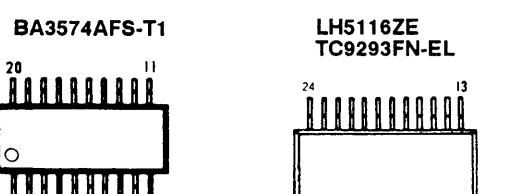
**SEE ADDITIONAL INFORMATION**

**5-1. BLOCK DIAGRAM**



## 5-2. PRINTED WIRING BOARDS

## • Semiconductor Lead Layouts



Note:  
 • : parts extracted from the component side.  
 • : Through hole.  
 • : internal component.  
 • : Pattern from the side which enables seeing.  
 (The other layers' patterns are not indicated.)

Caution:  
 Pattern face side: Parts on the pattern face side seen from the pattern face are indicated.  
 Parts face side: Parts on the parts face side seen from the parts face are indicated.

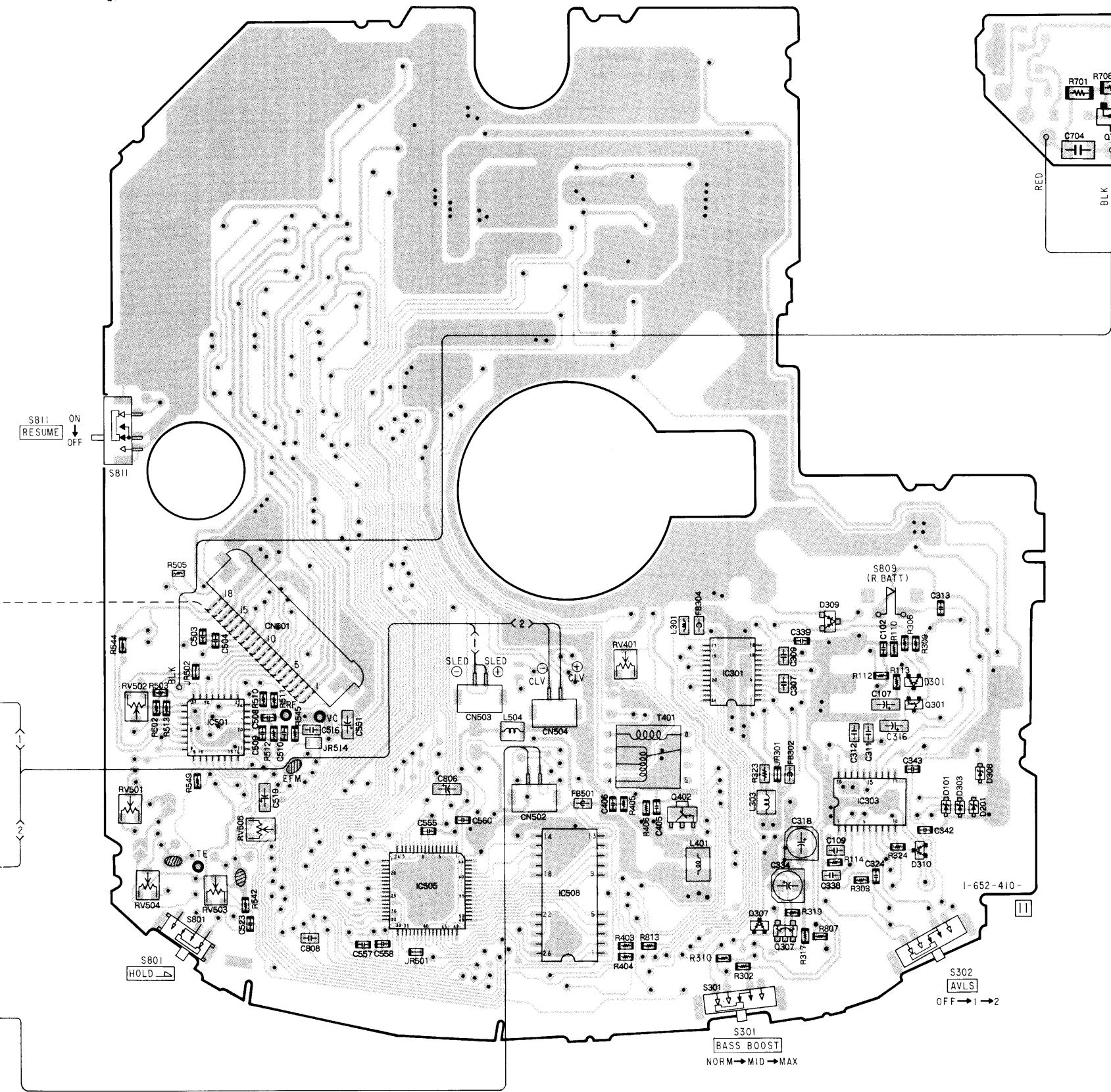
## • Semiconductor Location

Ref. No.	Location
D101	G-10
D201	G-10
D301	F-10
D303	G-10
D307	H-9
D308	G-10
D309	F-9
D310	G-10
D401	G-16
D402	B-15
D403	D-15
D404	B-15
D405	D-16
D501	B-17
D502	B-17
D503	D-17
D504	H-16
D506	D-17
D507	C-17
D508	E-17
D509	G-16
D701	B-12
D801	H-16
D802	H-16
D803	H-14
IC301	F-9
IC302	F-13
IC303	G-10
IC401	D-16
IC402	C-16
IC501	G-5
IC502	F-17
IC503	D-17
IC504	B-17
IC505	H-6
IC506	F-16
IC507	C-18
IC508	H-7
IC801	H-17
Q301	F-10
Q307	H-9
Q308	H-14
Q309	H-15
Q401	G-15
Q402	G-8
Q403	G-15
Q408	C-15
Q410	D-15
Q411	C-16
Q412	C-16
Q413	D-15
Q501	F-18
Q503	D-18
Q504	H-16
Q506	F-18
Q703	G-18
Q704	B-12
Q801	B-11
Q804	H-16
S901	H-19

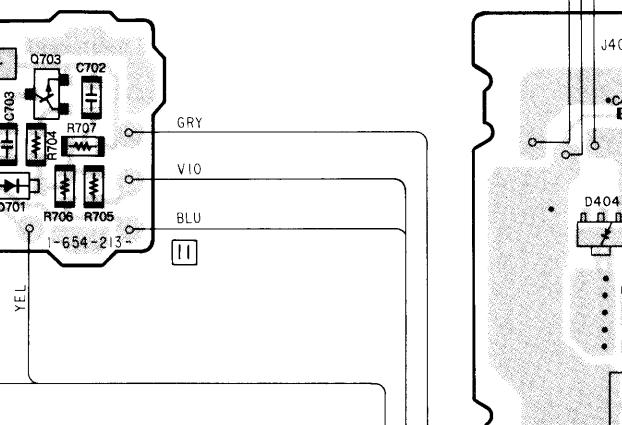
1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19
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SEE ADDITIONAL INFORMATION

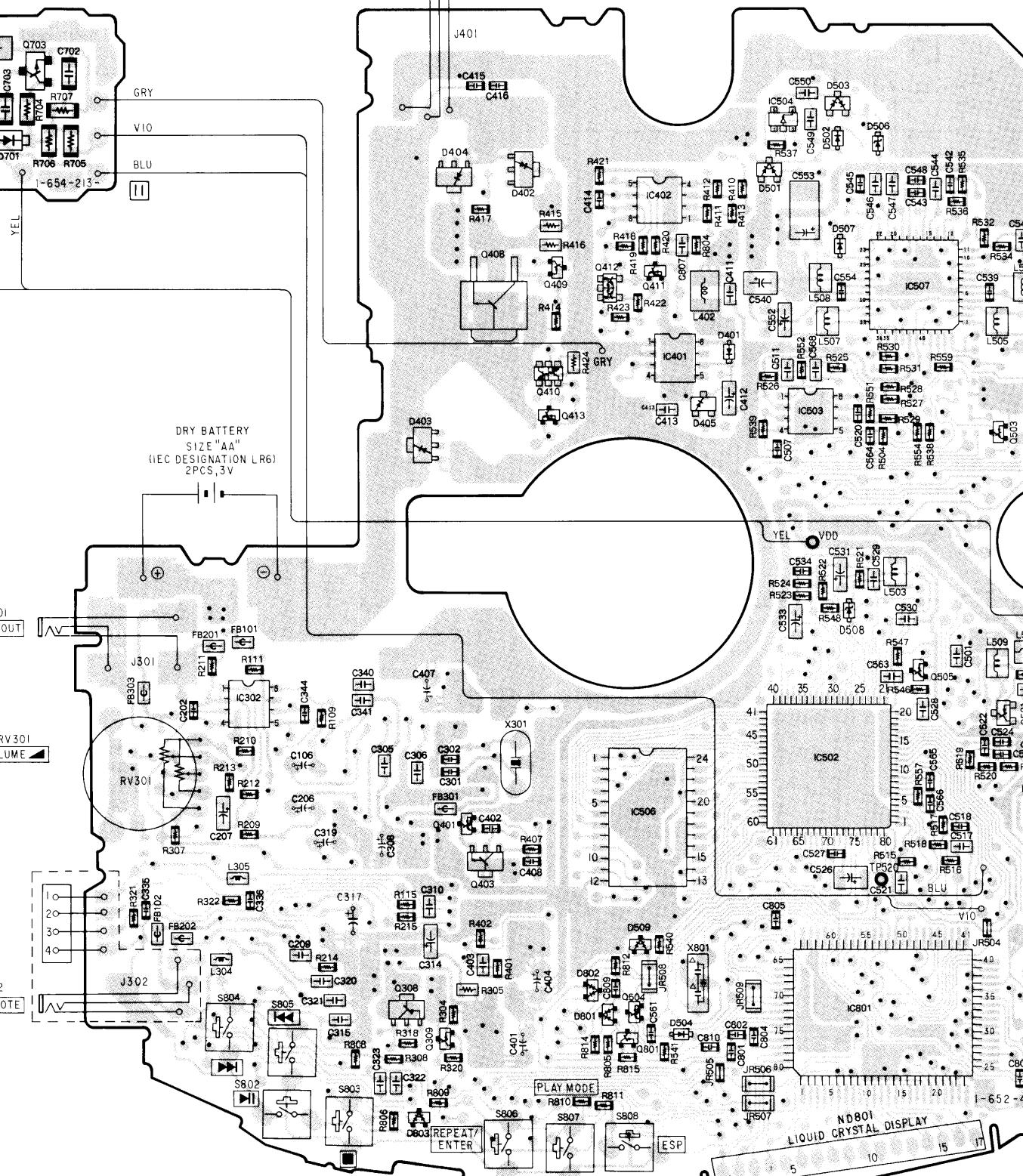
MAIN BOARD (SIDE A)



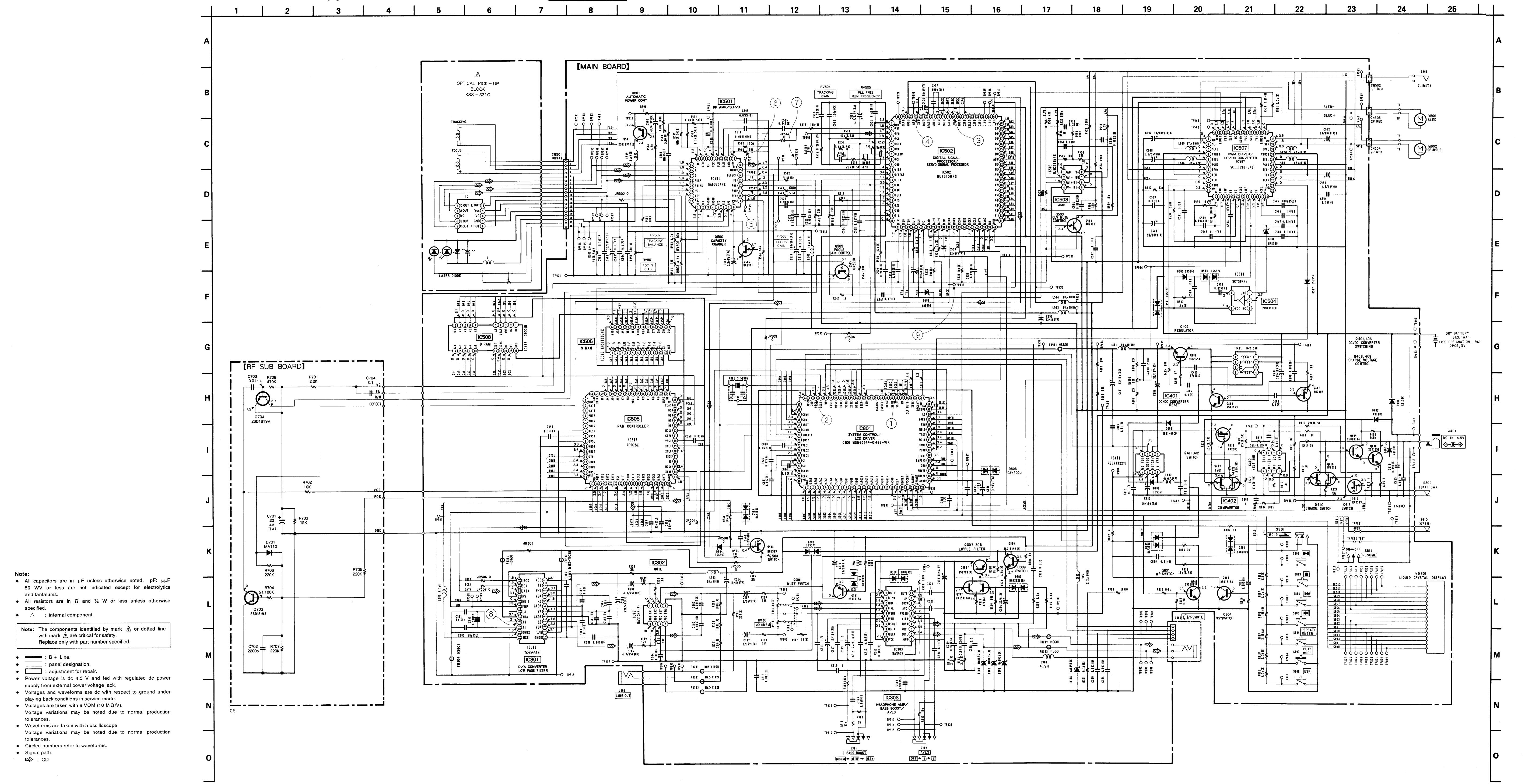
[RF SUB BOARD]



[MAIN BOARD] (SIDE B)

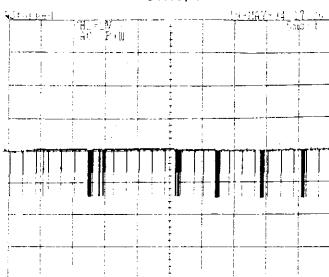


SEE ADDITIONAL INFORMATION

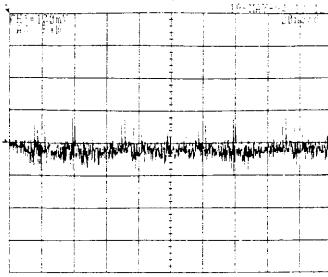


• Wave forms

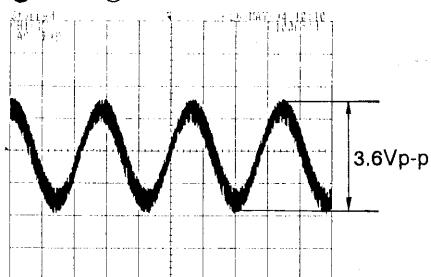
① IC801 ④ 2V/DIV  
5ms/DIV



⑥ TP FE 100mV/DIV  
20ns/DIV

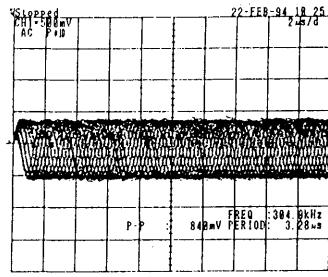


② IC801 ⑤

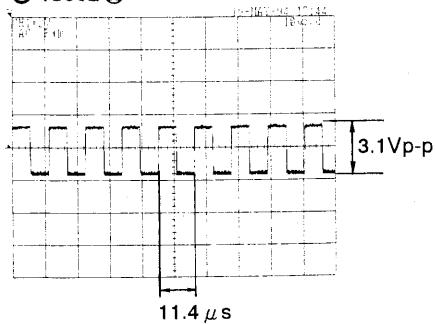


3.58MHz

⑦ IC501 ⑩ 500mV/DIV  
2 μ s/DIV

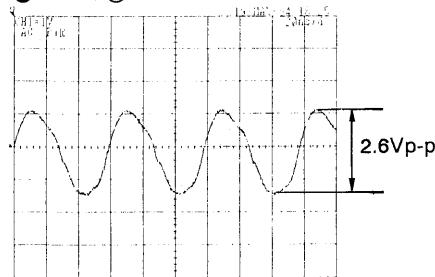


③ IC502 ⑨



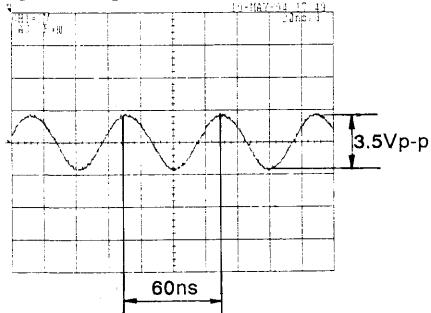
11.4 μ s

⑧ IC301 ⑯

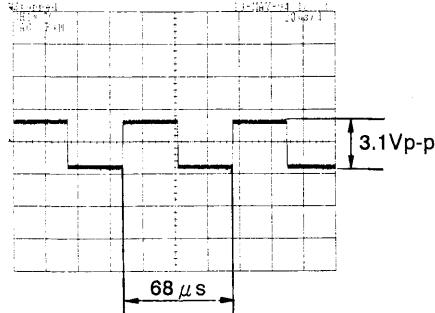


16.94MHz

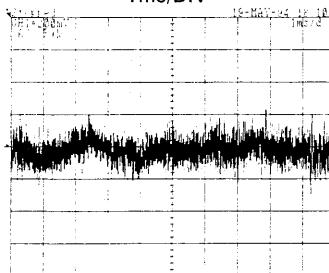
④ IC502 ⑯



⑨ IC502 ⑪



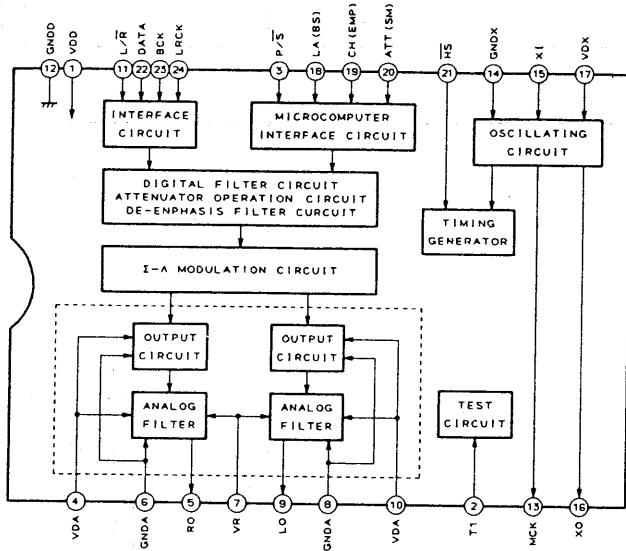
⑤ TP TE 200mV/DIV  
1ms/DIV



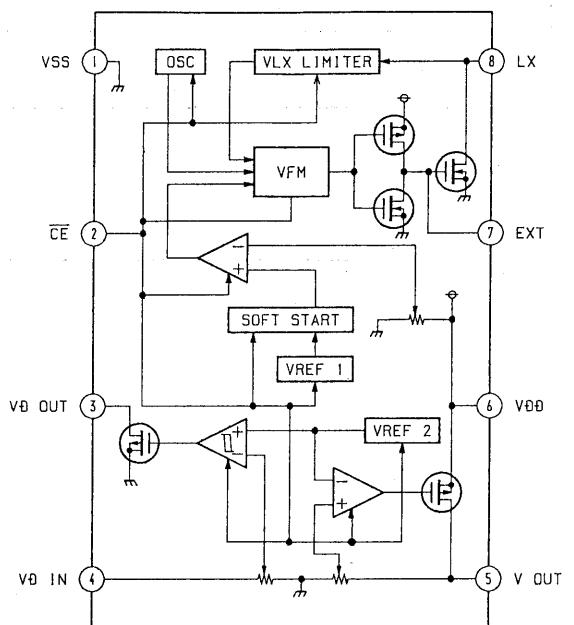
• IC Block Diagrams

MAIN BOARD

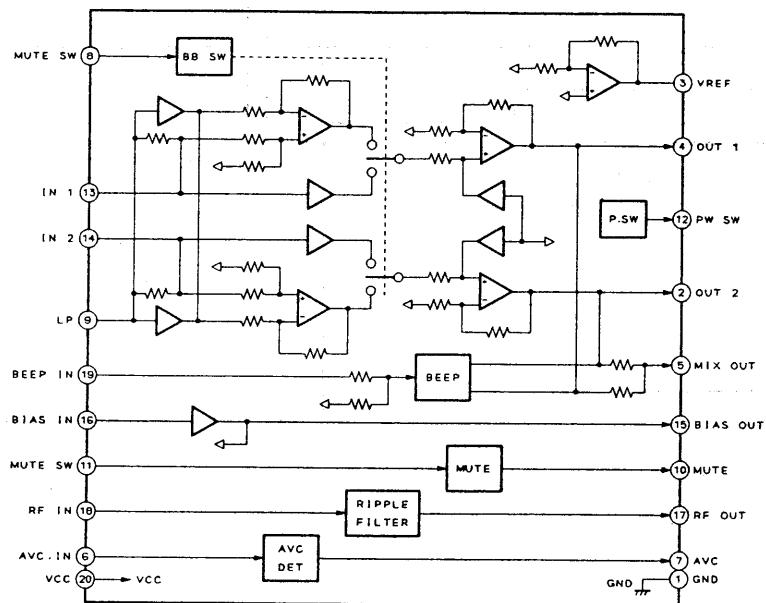
IC301 TC9293FN-EL



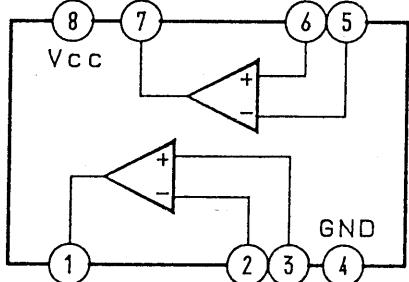
IC401 RS5RJ32271-T1



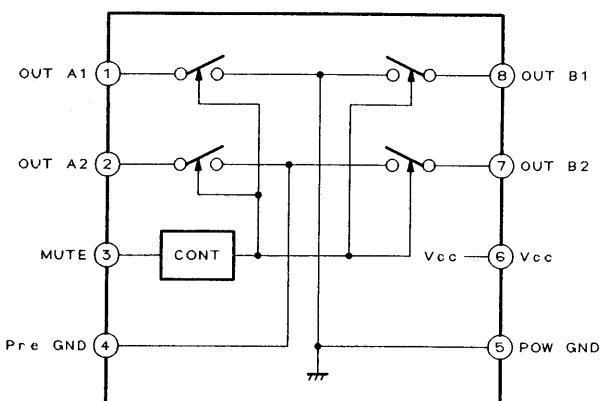
IC303 BA3574AFS-T1



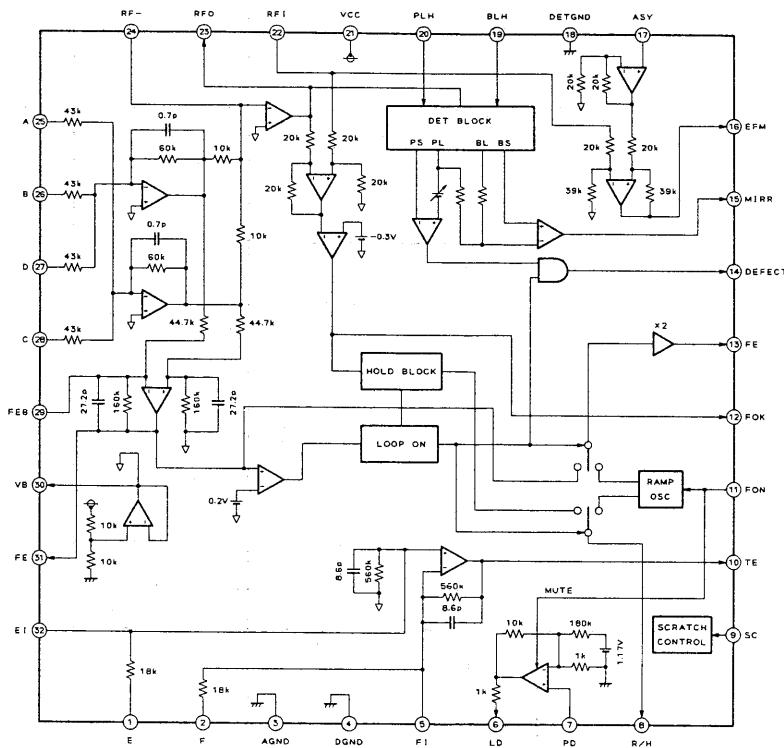
IC402, 503 NJM2100M



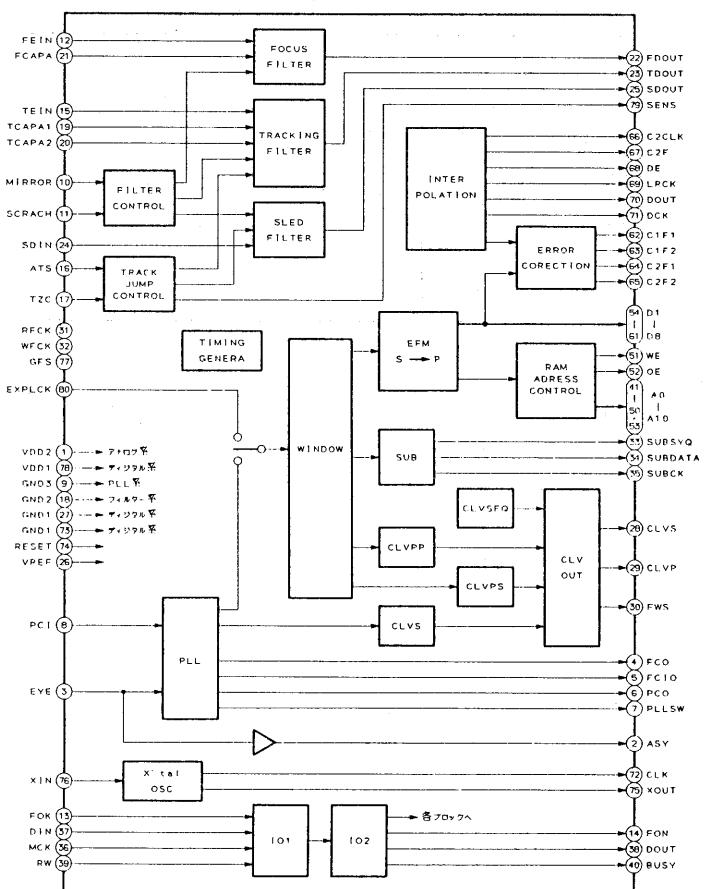
IC302 BA3124F-T1



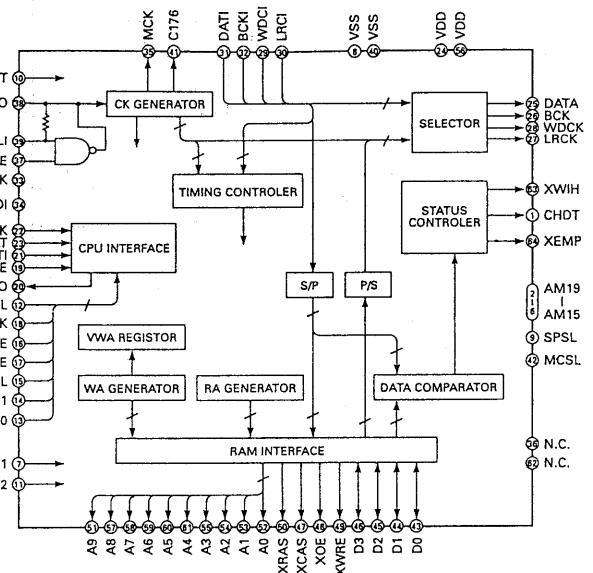
## IC501 BA6373K



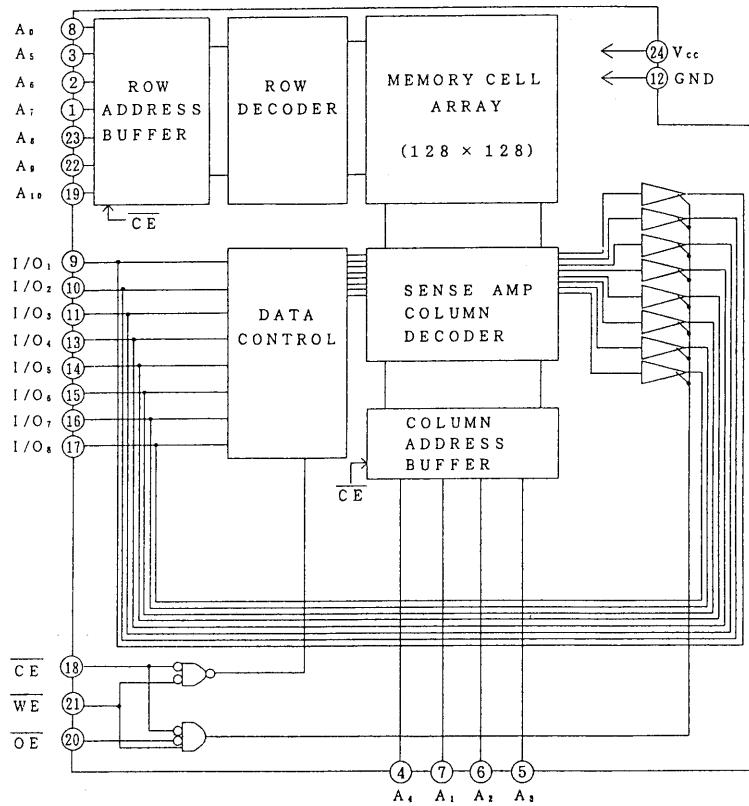
## IC502 BU9310BKS



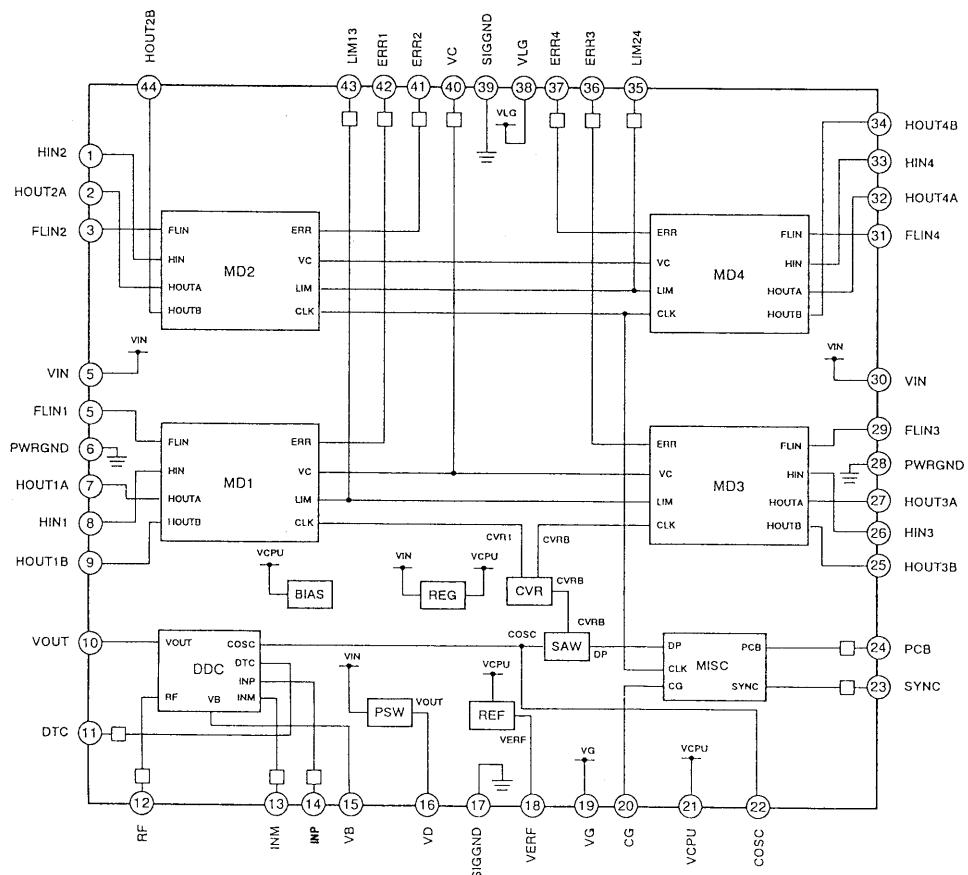
## IC505 RF5C241



## IC506 LH5116ZE



## IC507 SC111281FU



#### 5-4. IC PIN FUNCTION

MAIN BOARD IC801 MSM65344-014GS-V1K

Pin No.	Pin Name	I/O	Description
1	COM3	O	LCD drive output. Connected to LCD COM3.
2 – 14	SEG0 – 12	O	LCD drive output. Connected to LCD S0 – S12.
15 – 17	SEG13 – 15	—	Not used.
18	AGND	—	For A/D converter. Analog GND.
19	KEY	I	A/D key input of body key. PLAY(0.0), STOP(0.1VDD), FF(0.2VDD), FR(0.3VDD), PLAY MODE(0.4VDD), RPT/ENT(0.5VDD), ESP(0.6VDD)
20	RMKEY	I	A/D input of remote controller. FR/PLAY(0.9VDD), FF MODE(0.8VDD), STOP(0.7VDD)
21	VCCMNT	O	Voltage monitor of main DC-DC converter output.
22	BATMNT	I	Battery(DM-10/AM-3) voltage monitor.
23	CHGMNT	I	Charging voltage monitor in DM-10 rapid charging.
24	NC	I	Input terminal.
25	AVDD	—	Analog VDD.
26	D-MUTE	O	"H" digital mute ON. To TC9293FN.
27	A-MUTE	O	"H" analog mute ON.
28	CHG	O	"L" rapid charge ON.
29	EMPSIS	O	"H" emphasis ON. To TC9293FN.
30	LIGHT	—	Not used.
31	PCON	O	"L" power control ON. To SC111281LFU.
32	XDM1	I	"L" DM-10 IN. Charging battery detecting terminal.
33	DCIN	I	"L" DC IN. DC-IN detecting terminal.
34	TEST	I	"L" test (service) mode.
35	HOLD	I	"L" HOLD ON. To HOLD switch.
36	RSM	I	"L" RESUME ON. To RESUME switch.
37	OPEN	I	"L" CLOSE. To OPEN switch.
38	LS	I	"L" pick up clockwise circuit.
39	XSOE	O	"L" serial data permission. To RF5C241.
40	SCK	O	ESP serial clock. To RF5C241.
41	SDTI	I	ESP serial data input. From RF5C241.
42	DACLAT	—	Not used.
43	XWRE	O	Digital data writing permission signal, "L" permission. To RF5C241.
44	CLV-MUTE	O	CLV reverse prevention output. "L" CLV STOP.
45	RW	O	DSP serial data reading/writing switching singnal. To BU9310BKS.
46	SCLK	O	DSP serial clock. To BU9310BKS.
47	SUBQ	I	SUB-Q serial data input. To BU9310BKS.
48	DATA	O	DSP serial order output. To BU9310BKS.
49	ESPSL	—	Not used.
50	VCCADJ	—	Not used.
51	—	—	Not used.
52	VDD	—	Micro computer power supply. VDD=3.2V
53	BEEP	O	BEEP output.
54	DTSL	O	ESP/NORMAL switching terminal. ESP MODE with "H". To RF5C421.
55	XQOK	O	ESP sub code recognition signal. To RF5C241.

<b>Pin No.</b>	<b>Pin Name</b>	<b>I/O</b>	<b>Description</b>
56	SCOR	I	SCOR interrupting signal. From BU9310BKS.
57	XRDE	O	Readable with digital data reading permission signal, "L" from D-RAM. To RF5C241.
58	WDSL	O	ESP digital data connecting window selecting signal. To RF5C241.
59	FOKI	I	For FOCUS OK signal detection.
60	WP	I	Sleep mode canceling signal input terminal. Cancelled at trailing edge.
61	<u>OSCI</u>		System clock generating device connecting terminal.
62	OSC0		
63	GND	—	GND.
64	<u>RESET</u>	I	Micro computer reset terminal. "L" micro computer reset.
65	—	—	GND.
66	—	—	Not used.
67	CHM0	O	Digital data comparing mode SW0. To RFC5C241.
68	CHM1	O	Digital data comparing mode SW1. To RFC5C241.
69	XRST	O	System reset terminal "L" system IC reset.
70	C2MN	O	S-RAM over flow signal mute. "H" mute ON.
71	RMDATA	O	Data output for liquid crystal remote controller.
72	<u>BUSY</u>	I	"L" track jumping. To BU9310BKS.
73	VDD1	O	LCD driving bias output.
74	VDD2		
75	VDD3		
76	C1		LCD driving bias generating condenser connecting terminal.
77	C2		
78	COM0	O	LCD driving output. Connected to LCD COM0 – 2.
79	COM1		
80	COM2		

## SECTION 6

### EXPLODED VIEWS

**NOTE:**

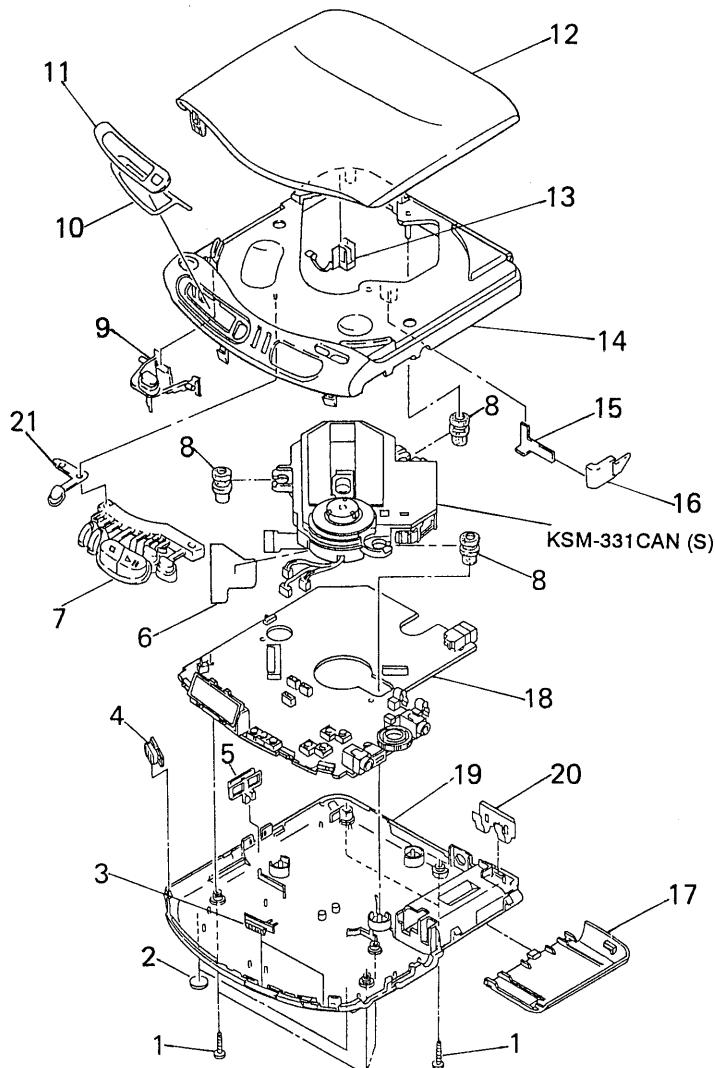
- -XX and -X mean standardized parts, so they may have some difference from the original one.
- Color Indication of Appearance Parts Example:  
KNOB, BALANCE (WHITE) ... (RED)  
↑                      ↑  
Parts Color   Cabinet's Color

- Items marked “\*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Hardware (# mark) list and accessories and packing materials are given in the last of the electrical parts list.

The components identified by mark  $\Delta$  or dotted line with mark  $\Delta$  are critical for safety.  
Replace only with part number specified.

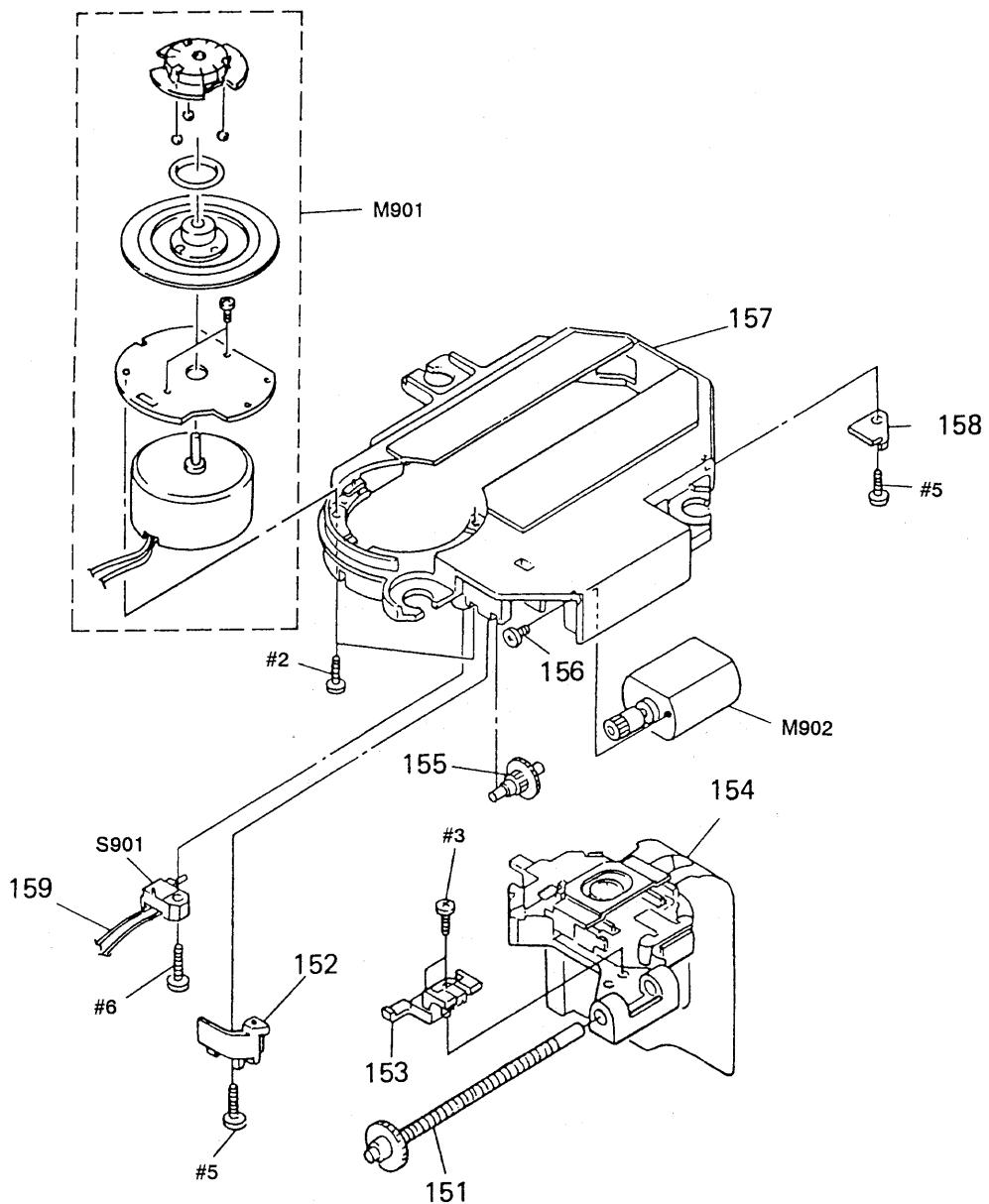
- Abbreviation  
MX : Mexican

**(1) CABINET SECTION**



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
1	4-958-597-01	SCREW		12	4-964-907-31	LID (U), UPPER (BLUE)	
2	4-962-025-01	FOOT, RUBBER		13	4-964-896-01	SPRING (OPEN)	
3	4-964-894-01	KNOB (A/B)		14	4-964-906-01	CABINET (FRONT)	
4	4-964-893-01	KNOB (HOLD)		15	4-964-897-01	SPRING (SEPARATOR)	
5	4-964-895-01	KNOB (RESUME)		16	4-964-892-01	SEPARATOR	
6	4-956-818-01	RETAINER, FLEXIBLE		17	4-964-904-01	LID, BATTERY CASE	
7	4-964-902-01	BUTTON (OPE)		18	A-3276-372-A	MAIN BOARD, COMPLETE (US, AEP, E, MX)	
8	4-947-759-01	INSULATOR (I)		18	A-3276-500-A	MAIN BOARD, COMPLETE (UK)	
9	4-964-901-01	BUTTON (OPEN)		* 19	4-964-905-21	CABINET (REAR)	
10	4-965-963-01	SHEET (LCD WINDOW), ADHESIVE		20	4-944-349-11	TERMINAL BOARD (RELAY), BATTERY	
11	4-964-900-01	WINDOW (LCD)		21	4-964-903-01	BUTTON (ESP)	
12	4-964-907-11	LID (U), UPPER (BLACK)					

(2) OPTICAL PICK-UP BLOCK SECTION  
(KSM-331CAN (S))



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
151	X-2625-483-1	SCREW ASSY, SLED		157	2-625-415-05	CHSSIS, MD	
152	2-625-412-02	SPRING, SLED		158	2-625-411-01	RETAINER, SHAFT	
153	2-625-414-02	RACK		159	1-948-418-21	HARNESS	
△154	8-848-295-51	DEVICE, OPTICAL (KSS-331C)		M901	X-2625-485-1	MOTOR ASSY, T. T. (SPINDLE)	
155	2-625-410-01	GEAR (B)		M902	X-2625-171-2	MOTOR ASSY, SLED	
156	3-732-988-01	SCREW (M2X2.5)		S901	1-570-771-11	SWITCH (LIMIT)	

Note: The components identified by mark △ or dotted line with mark △ are critical for safety.  
Replace only with part number specified.











Ref. No.	Part No.	Description	Remark
*	4-966-834-01	INDIVIDUAL CARTON (US)	
*	4-968-365-01	INDIVIDUAL CARTON (AEP, UK)	
*	4-968-366-01	INDIVIDUAL CARTON (MX)	
*	4-968-371-01	INDIVIDUAL CARTON (E)	
	8-953-011-90	HEADPHONE MDR-014B//0 SET (US)	
	8-953-537-91	HEADPHONE MDR-E741MP//K1 SET (E, MX)	
	8-953-538-91	HEADPHONE MDR-E741//K1 SET (AEP, UK)	

\*\*\*\*\*  
**HARDWARE LIST**  
\*\*\*\*\*

- #2 7-627-852-17 SCREW, PRECISION +P 1.7X4
- #3 7-627-852-18 SCREW, PRECISION +P 1.7X4 TYPE 3
- #5 7-685-104-19 SCREW (2X6), TAPPING (B)
- #6 7-685-105-19 SCREW (2X8), TAPPING (B)

English  
94F05101-1  
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**Sony Corporation**  
Consumer A&V Products Company  
Personal A&V Products Div.

Published by Home A&V Products Div.  
Quality Engineering Dept.

REVISED

D-231

# SONY SERVICE MANUAL

US Model  
AEP Model  
UK Model  
E Model

## SUPPLEMENT-1

File this supplement with the service manual.

Subject: 1. Board Modification

 2. Correction

(ECN-CD450600)

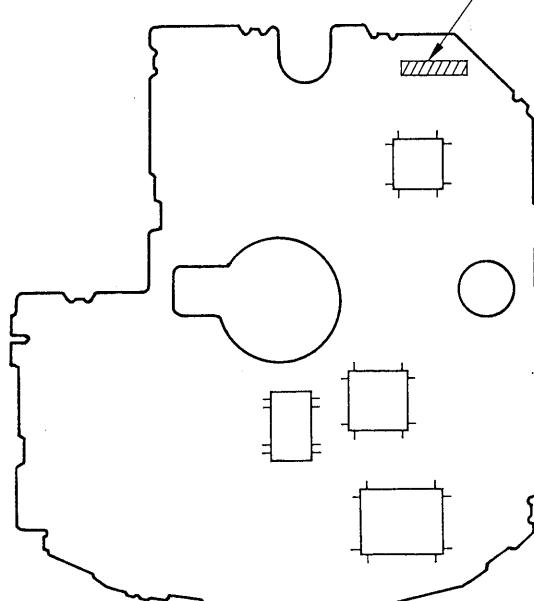
### 1. BOARD MODIFICATION

Two types of the printed circuit board exist because the board type has been changed in the production. This manual contains the block diagram, the printed wiring boards, the schematic diagram, and the electrical parts list of only the new board type. For other information, refer to the D-231 service manual (9-959-620-11) previously issued.

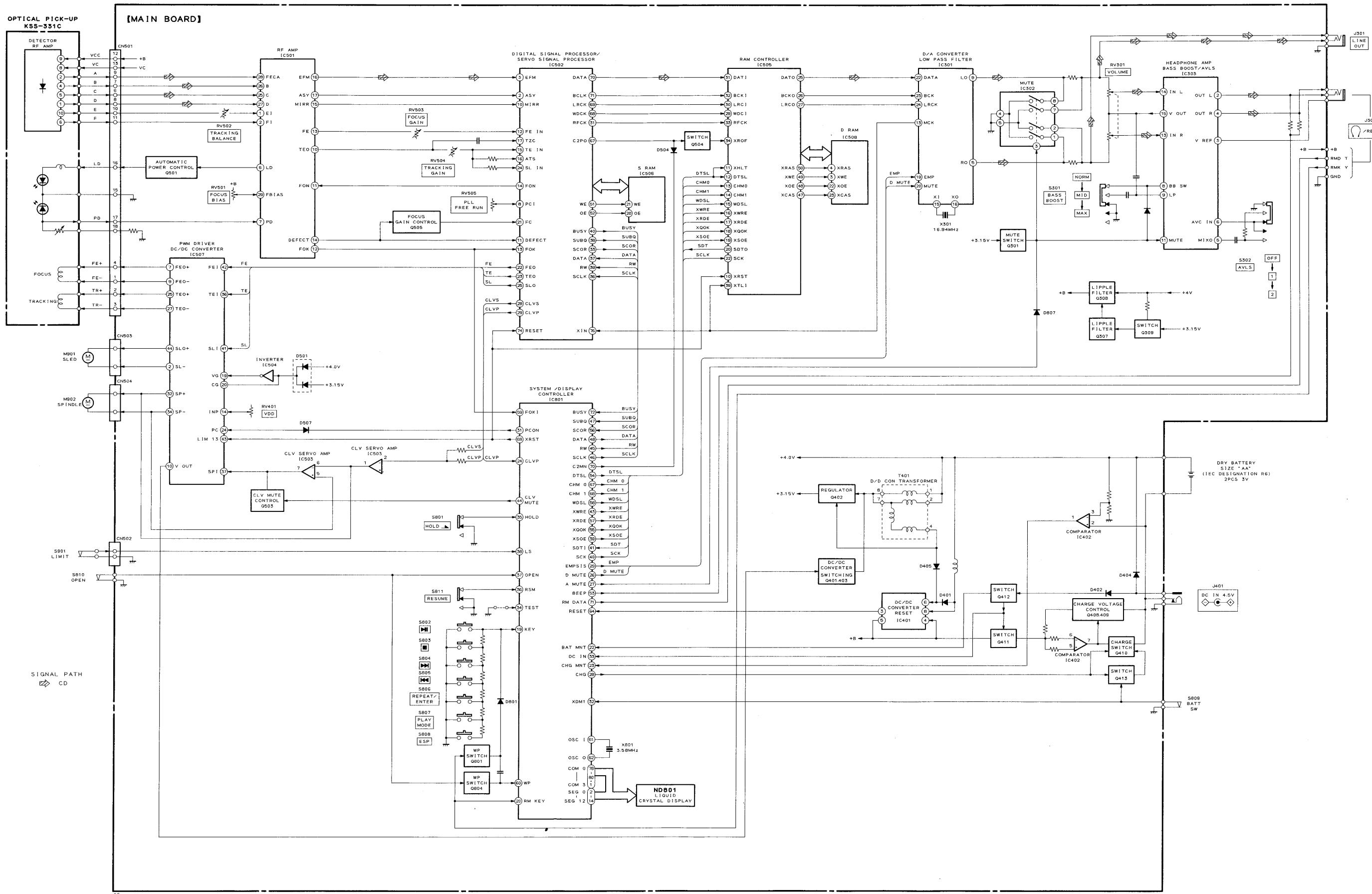
#### • New/Former Discrimination

Former Type : 1-652-410-11  
New Type : 1-652-410-12 (Type A)  
: 1-652-410-13 (Type B)

MAIN BOARD – SIDE B –



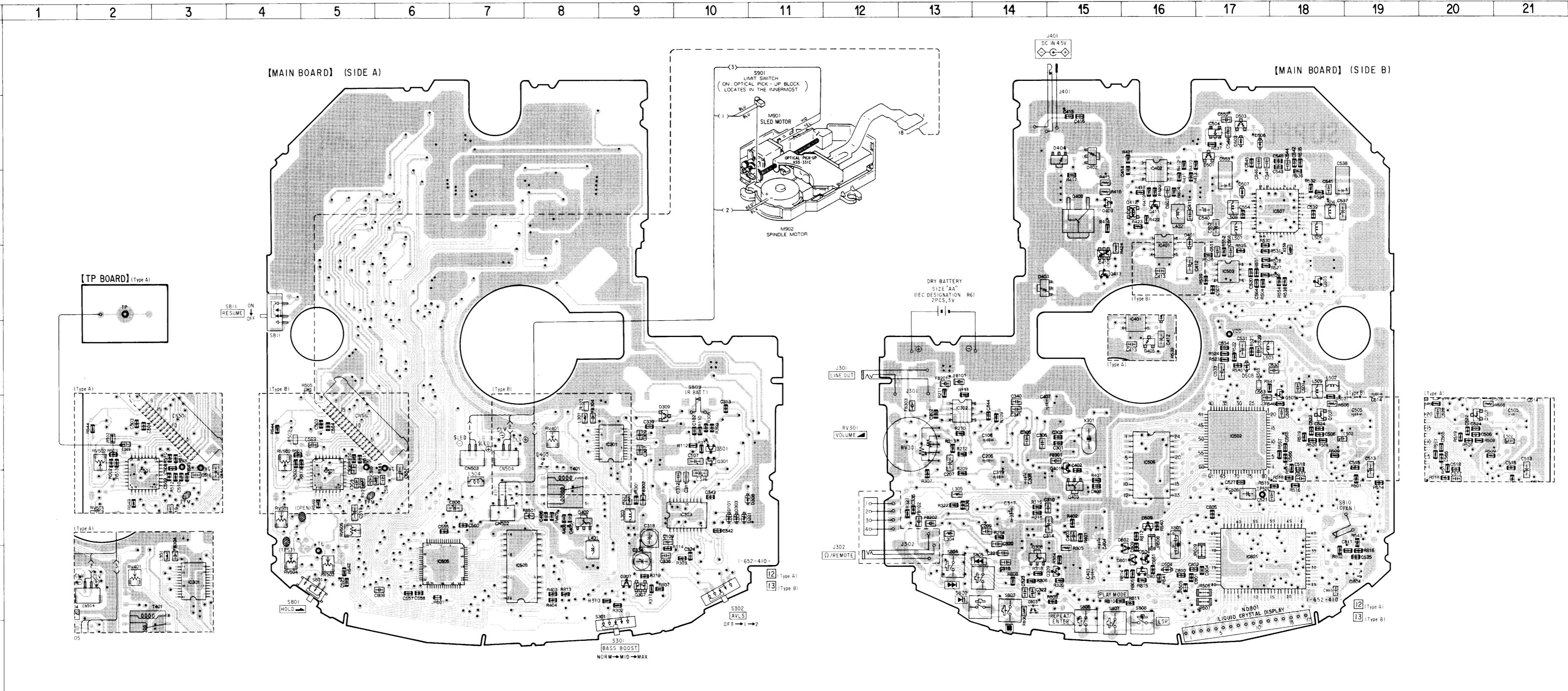
## 1-1. BLOCK DIAGRAM



## 1-2. PRINTED WIRING BOARDS

- Semiconductor Location

Ref. No.	Location
D101	G-10
D201	G-10
D301	F-10
D303	G-10
D307	H-9
D308	G-10
D309	F-9
D401	C-16
D402	B-15
D403	D-14
D404	B-15
D405	F-8 (TYPE B)
D405	E-16 (TYPE A)
D501	B-17
D502	B-17
D503	B-17
D504	H-16
D506	B-17
D507	C-17
D508	E-17
D509	G-16
D801	H-16
D802	H-16
D803	H-14
IC301	F-9
IC302	F-13
IC303	G-10
IC401	D-16
IC402	C-16
IC501	G-5
IC502	F-17
IC503	D-17
IC504	B-17
IC505	H-6
IC506	F-16
IC507	H-7
IC508	C-18
IC801	H-17
O301	F-10
O307	H-9
O308	H-14
O309	H-15
O401	G-15
O402	G-8
O403	G-15
O408	C-15
O409	C-15
O410	D-15
O411	C-16
O412	C-16
O413	D-15
O501	F-18
O503	D-18
O504	H-16
O505	F-18
O801	H-16
O804	H-19



## Note:

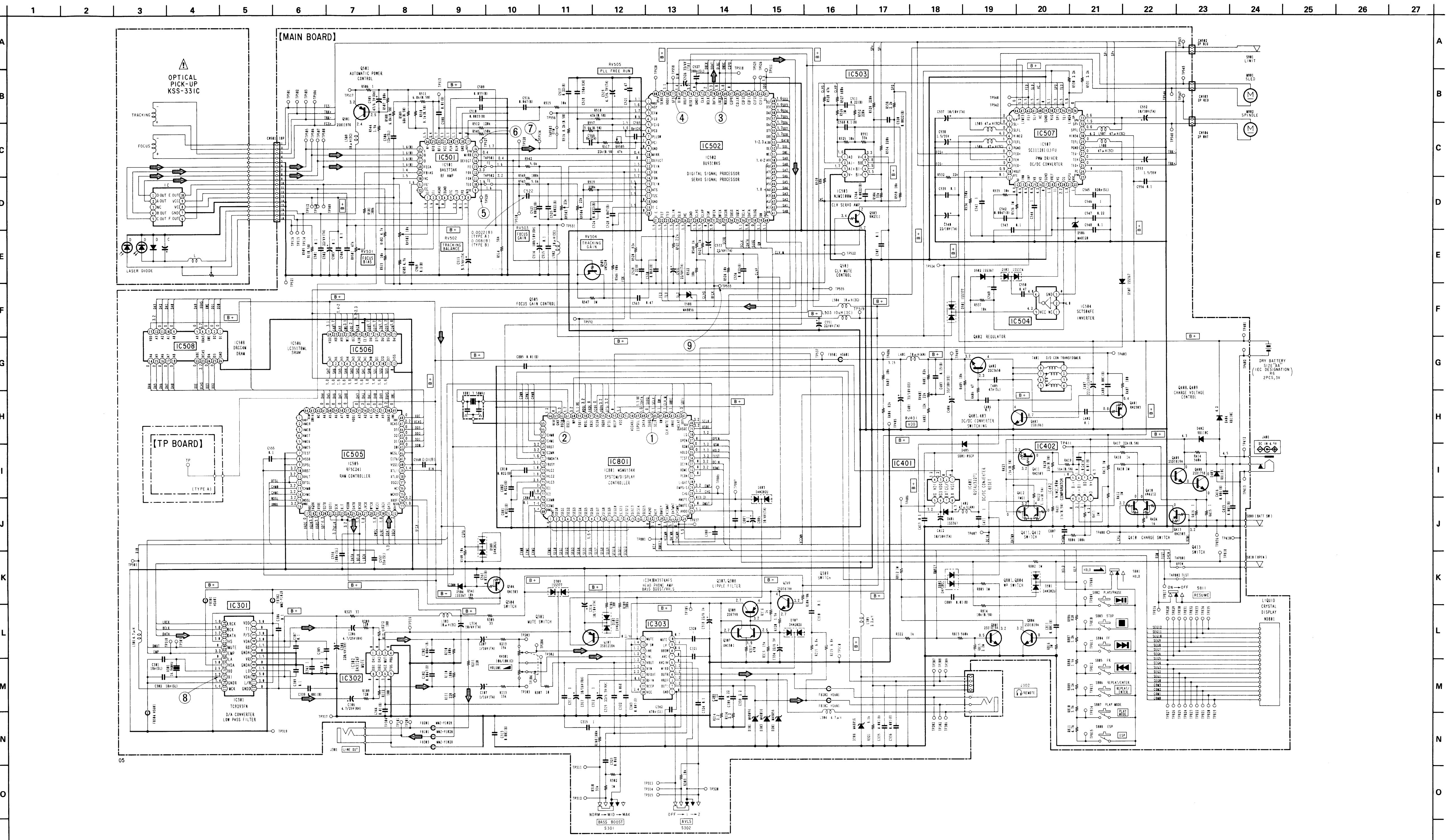
- : parts extracted from the component side.
- : Through hole.
- △ : internal component.
- : Pattern from the side which enables seeing.

(The other layers' patterns are not indicated.)

## Caution:

- Pattern face side: Parts on the pattern face side seen from the pattern face are indicated.  
 Parts face side: Parts on the parts face side seen from the parts face are indicated.

## 1-3. SCHEMATIC DIAGRAM











Ref. No.	Part No.	Description	Remark		
R813	1-216-854-11	METAL CHIP	560K	5%	1/16W
R814	1-218-716-11	METAL CHIP	10K	0.50%	1/16W
R815	1-216-861-11	METAL CHIP	2.2M	5%	1/16W
R816	1-216-857-11	METAL CHIP	1M	5%	1/16W

## &lt; VARIABLE RESISTOR &gt;

RV301 1-223-382-11 RES, VAR, CARBON 10K/10K (VOLUME)  
 RV401 1-223-578-11 RES, ADJ, METAL GLAZE 22K  
 RV501 1-223-612-11 RES, ADJ, METAL GLAZE 47K  
 RV502 1-223-695-11 RES, ADJ, METAL GLAZE 10K  
 RV503 1-223-578-11 RES, ADJ, METAL GLAZE 22K  
 RV504 1-223-578-11 RES, ADJ, METAL GLAZE 22K  
 RV505 1-223-612-11 RES, ADJ, METAL GLAZE 47K

## &lt; SWITCH &gt;

S301 1-692-605-11 SWITCH, SLIDE (BASS BOOST)  
 S302 1-692-605-11 SWITCH, SLIDE (AVLS)  
 S801 1-572-922-11 SWITCH, SLIDE (HOLD)  
 S802 1-572-198-11 SWITCH, KEYBOARD (▶■)  
 S803 1-572-198-11 SWITCH, KEYBOARD (■)  
 S804 1-572-198-11 SWITCH, KEYBOARD (▶▶)  
 S805 1-572-198-11 SWITCH, KEYBOARD (◀◀)  
 S806 1-572-198-11 SWITCH, KEYBOARD (REPEAT/ENTER)  
 S807 1-572-198-11 SWITCH, KEYBOARD (PLAY MODE)  
 S808 1-572-198-11 SWITCH, KEYBOARD (ESP)  
 S809 1-692-532-21 SWITCH, PUSH (1 KEY) (BATT SW)  
 S810 1-570-953-11 SWITCH, PUSH (1 KEY) (OPEN)  
 S811 1-572-922-11 SWITCH, SLIDE (RESUME)

## &lt; TRANSFORMER &gt;

T401 1-423-636-11 TRANSFORMER, DC-DC CONVERTER

## &lt; VIBRATOR &gt;

X301 1-579-345-11 VIBRATOR, CERAMIC (16.94 MHz)  
 X801 1-579-956-11 VIBRATOR, CERAMIC (3.58 MHz)

**REVISED**

**2. CORRECTION**

**2-1 ELECTRICAL PARTS LIST**

Page	Ref. No.	Incorrect		Correct	
		<u>Part No.</u>	<u>Description</u>	<u>Part No.</u>	<u>Description</u>
31	IC506	8-759-264-81	IC LH5116ZE	8-759-822-79	IC LC3517RM-15